

Description

The PNM3FD7002EN uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.

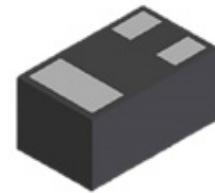
MOSFET Product Summary			
$V_{DS}(V)$	$R_{DS(on)}(\Omega)(Typ)$	$I_D(A)$	
60	1.4 @ $V_{GS} = 10V$	0.5	
	1.6 @ $V_{GS} = 4.5V$		
ESD	HBM		
	Pass 2kV		

Feature

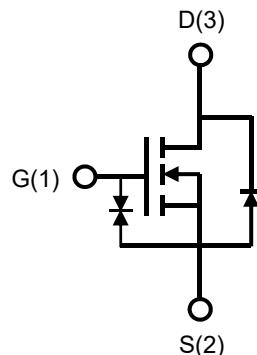
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Applications

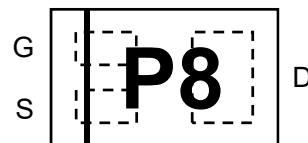
- PWM applications
- Load switch
- Power management
- DC-DC Converters
- Wireless Chargers



**DFN1006-3L
(Bottom View)**



Circuit Diagram



Marking (Top View)

Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous ¹⁾	I_D	0.5	A
		0.4	
Pulsed Drain Current ²⁾	I_{DM}	1.5	A
Total Power Dissipation ³⁾	P_D	1.1	W
Thermal Resistance Junction-to-Ambient ⁴⁾	$R_{\theta JA}$	113	°C/W
Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	°C

Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	60	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1.0	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 10	μA
On Characteristics						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.6	2.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 0.3A$	-	1.4	2.6	Ω
		$V_{GS} = 4.5V, I_D = 0.2A$	-	1.6	3.0	
Dynamic Characteristics⁵⁾						
Input Capacitance	C_{iss}	$V_{DS} = 30V, V_{GS} = 0V, f = 1.0MHz$	-	27	-	pF
Output Capacitance	C_{oss}		-	8.5	-	
Reverse Transfer Capacitance	C_{rss}		-	3.0	-	
Switching Characteristics⁵⁾						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 50V, V_{GS} = 10V, R_G = 6\Omega, I_D = 0.2A$	-	7.0	-	ns
Turn-on Rise Time	t_r		-	5.0	-	
Turn-Off Delay Time	$t_{d(off)}$		-	19	-	
Turn-Off Fall Time	t_f		-	21	-	
Total Gate Charge	Q_g	$V_{DS} = 30V, V_{GS} = 10V, I_D = 0.2A$	-	0.81	-	nC
Gate-Source Charge	Q_{gs}		-	0.02	-	
Gate-Drain Charge	Q_{gd}		-	0.56	-	
Drain-Source Diode Characteristics						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0V, I_S = 0.2A$	-	0.7	1.2	V

Notes:

1. Computed continuous current assumes the condition of T_{J_Max} while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. Repetitive Rating: Pulse width limited by maximum junction temperature ($T_{J_Max}=150^{\circ}C$).
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
5. Guaranteed by design, not subject to production.

Typical Characteristics

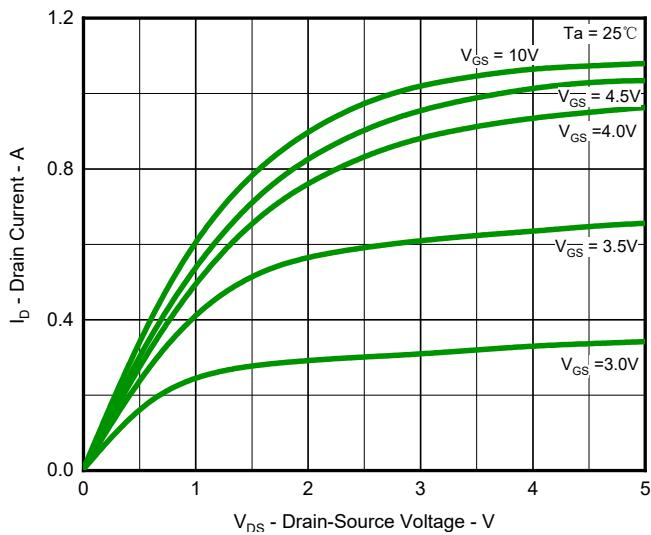


Fig.1 Output Characteristics

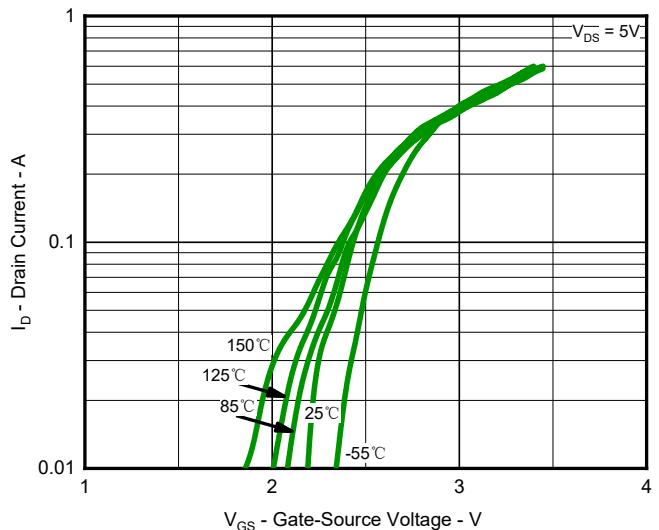


Fig.2 Typical Transfer Characteristic

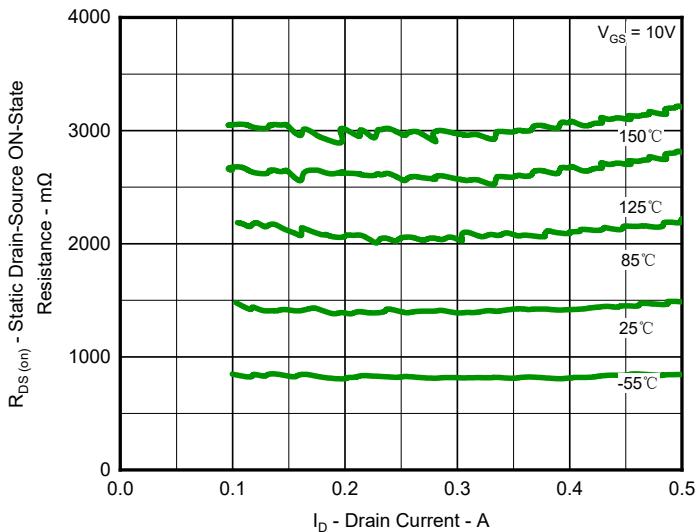


Fig.3 Typical On-Resistance vs. Drain Current and Temperature

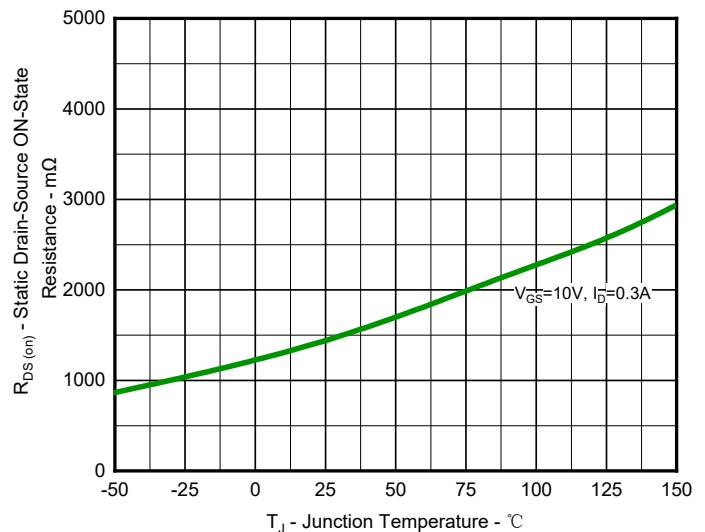


Fig.4 On-Resistance Variation with Temperature

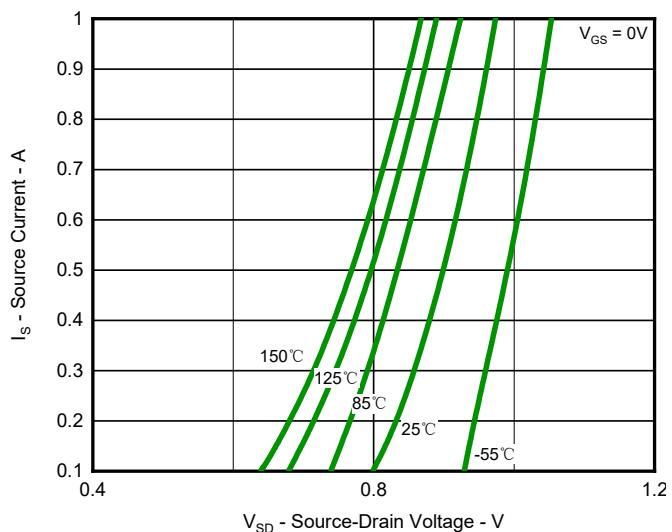


Fig.5 Diode Forward Voltage vs. Current

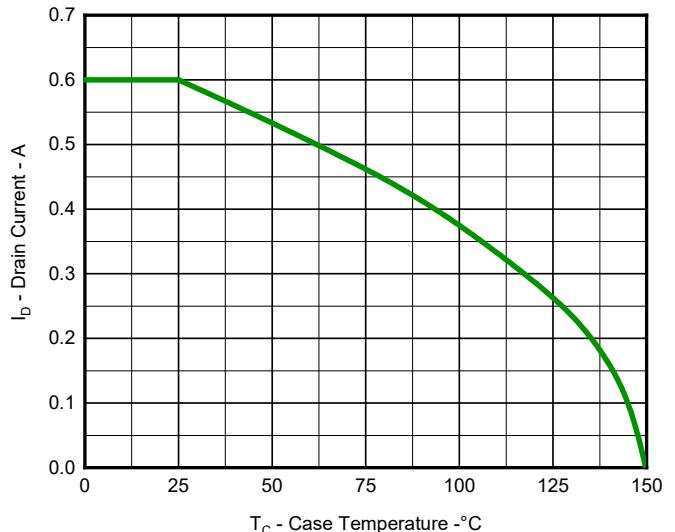


Fig.6 Maximum Drain Current vs. Case Temperature

N-Channel MOSFET

PNM3FD7002EN

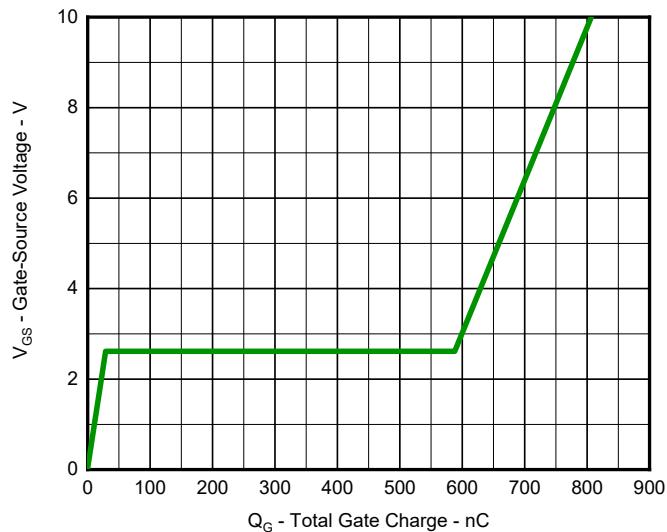


Fig.7 Gate Charge Characteristics

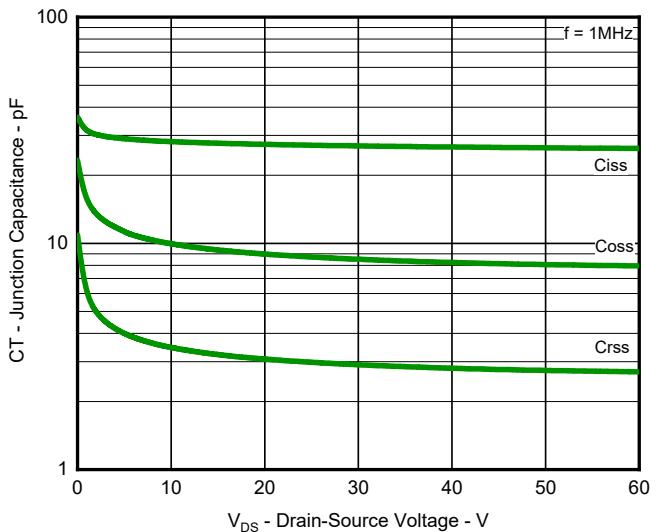


Fig.8 Typical Junction Capacitance

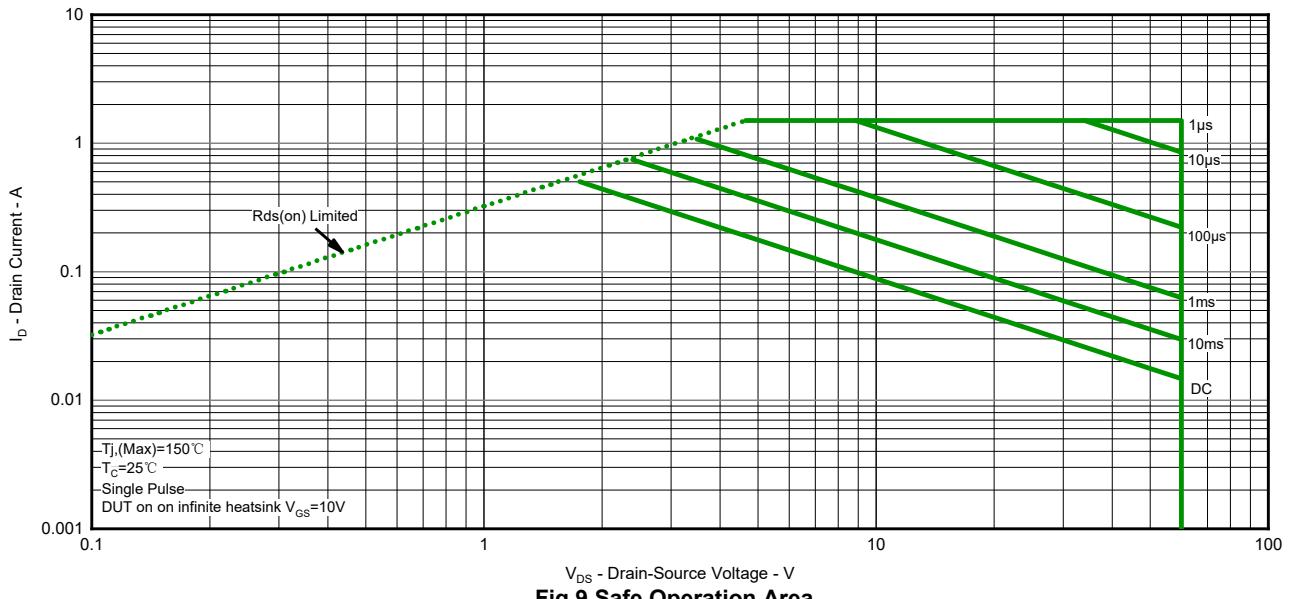


Fig.9 Safe Operation Area

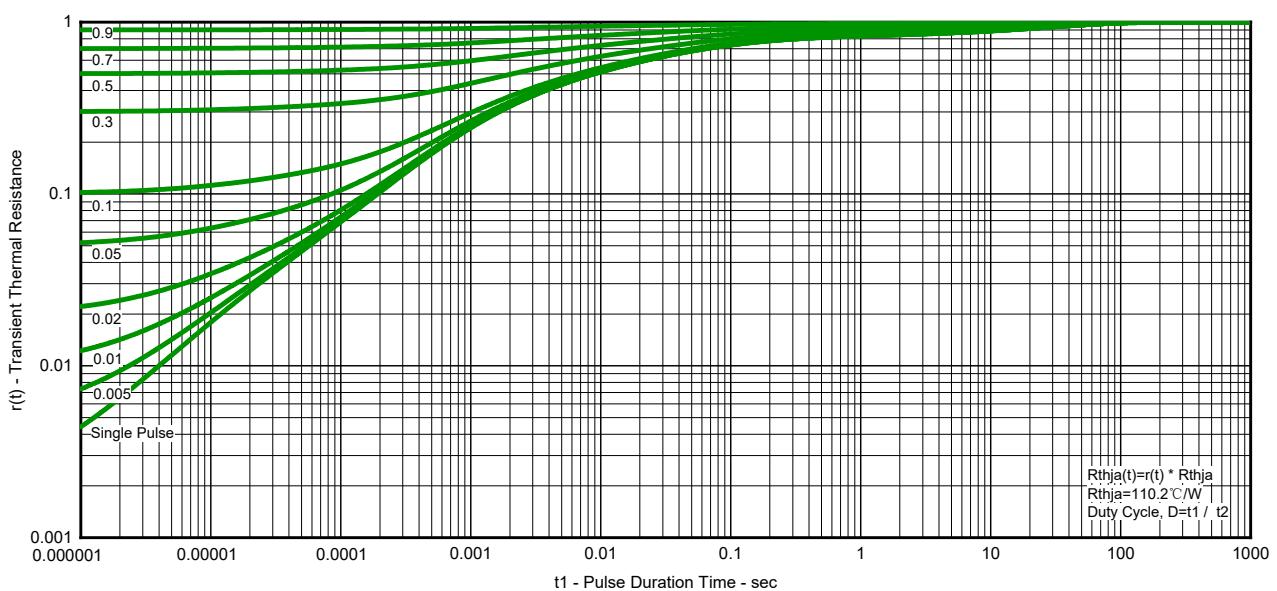
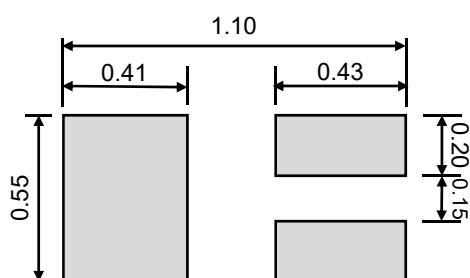
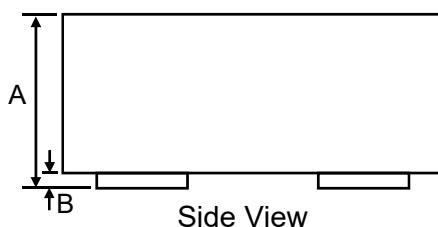
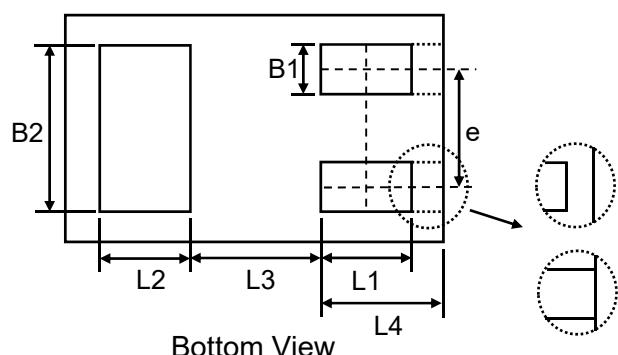
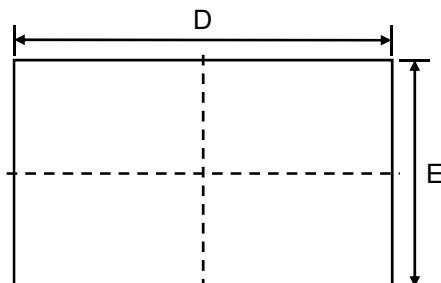


Fig.10 Transient Thermal Resistance

Product Dimension (DFN1006-3L)



Suggested PCB Layout

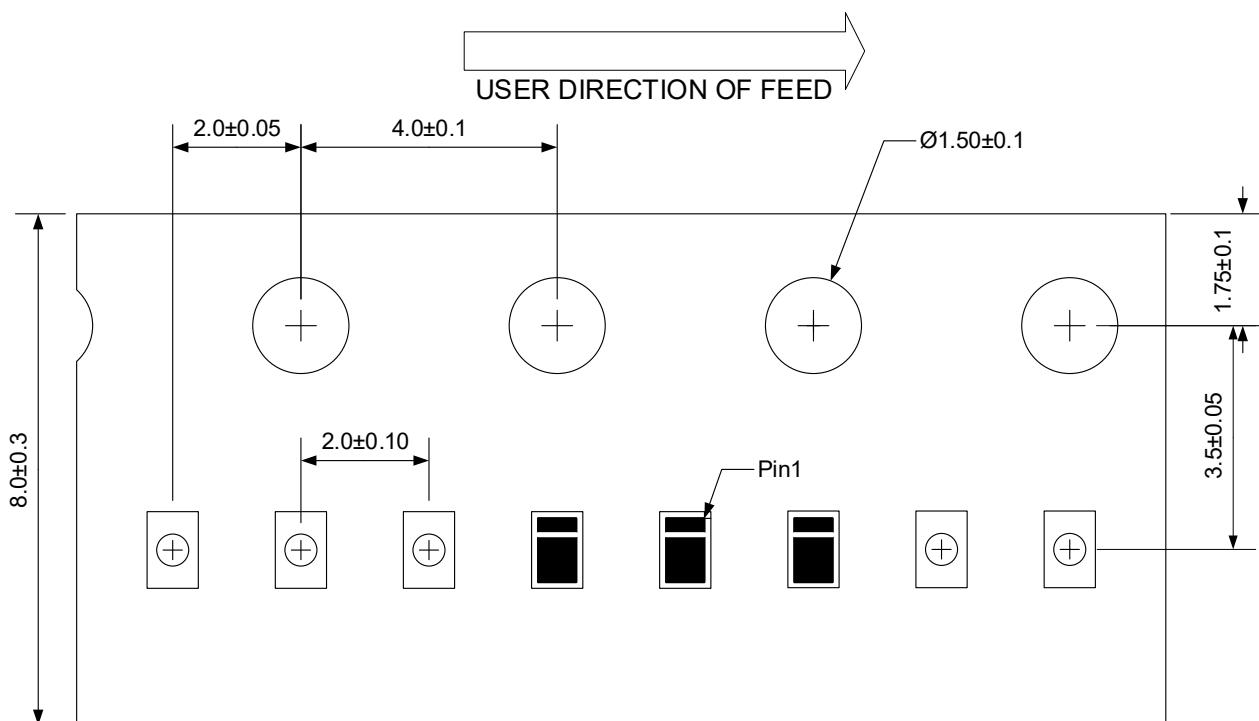
Unit: mm

Dim	Millimeters		Inches	
	Min	Max	Min	Max
A	0.33	0.55	0.013	0.022
B	0.00	0.05	0.000	0.002
B1	0.10	0.20	0.004	0.008
B2	0.45	0.55	0.018	0.022
D	0.90	1.05	0.035	0.041
E	0.50	0.65	0.020	0.026
e	0.35		0.014	
L1	0.20	0.30	0.008	0.012
L2	0.20	0.30	0.008	0.012
L3	0.39		0.015	
L4	0.25	0.35	0.010	0.014

Ordering information

Package	Reel	Shipping
DFN1006-3L	7"	10000 / Tape & Reel

Load with information



Unit:mm

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